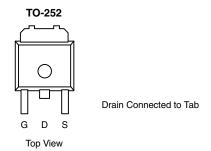


N-Channel 150 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
150	0.095 at $V_{GS} = 10 \text{ V}$	15		
150	0.100 at V _{GS} = 6 V	15		



Ordering Information: SUD15N15-95-E3 (Lead (Pb) free)

FEATURES

- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature

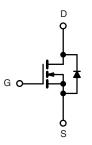


100 % R_g Tested

Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

· Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter		Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	150	V		
Gate-Source Voltage		V _{GS}	± 20	V		
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 25 °C	- I _D	15			
	T _C = 125 °C		8.7			
Pulsed Drain Current		I _{DM}	25	Α		
Continuous Source Current (Diode Conduction)		I _S	15			
Avalanche Current	I _{AR}	15				
Repetitive Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AR}	11.3	mJ		
Manianus Dania Discipation	T _C = 25 °C	P _D	62 ^b	W		
Maximum Power Dissipation	T _A = 25 °C	'D	2.7 ^a	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Junction-to-Ambient ^a	t ≤ 10 s	- R _{thJA}	16	20	°C/W	
Junction-to-Ambient*	Steady State		45	55		
Junction-to-Case		R _{thJC}	2	2.4		

- a. Surface mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.



Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static					<u>l</u>		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2			V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 120 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I_{DSS}	V _{DS} = 120 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 120 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	25			Α	
		V _{GS} = 10 V, I _D = 15 A		0.077	0.095		
h	В	V _{GS} = 10 V, I _D = 15 A, T _J = 125 °C			0.190		
Drain-Source On-State Resistance ^b	$R_{DS(on)}$	V _{GS} = 10 V, I _D = 15 A, T _J = 175 °C			0.250	Ω	
		V _{GS} = 6 V, I _D = 10 A		0.081	0.100		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		25		S	
Dynamic ^a							
Input Capacitance	C _{iss}			900		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		115			
Reverse Transfer Capacitance	C _{rss}			70			
Total Gate Charge ^c	Q _g			20	25		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 15 \text{ A}$		5.5		nC	
Gate-Drain Charge ^c	Q _{gd}			7			
Gate Resistance	R _g		1		3.2	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	12		
Rise Time ^c	t _r	$V_{DD} = 75 \text{ V}, R_L = 5 \Omega$		35	55		
Turn-Off Delay Time ^c	t _{d(off)}	$I_{D} \cong 15 \text{ A}, V_{GEN} = 10 \text{ V}, R_{G} = 2.5 \Omega$		17	25	ns	
Fall Time ^c	t _f			30	45		
Source-Drain Diode Ratings and Cha	racteristic (T	C = 25 °C)		_			
Pulsed Current	I_{SM}				25	Α	
Diode Forward Voltage ^b	V _{SD}	I _F = 15 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 15 A, dl/dt = 100 A/μs		55	85	ns	

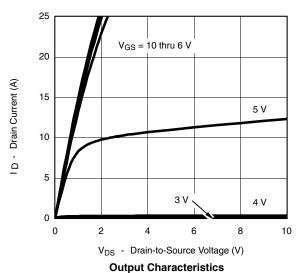
Notes:

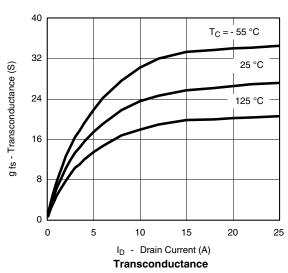
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- c. Independent of operating temperature.

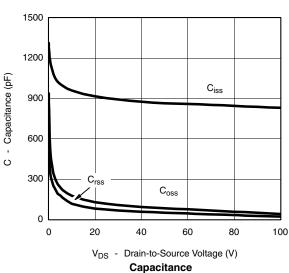
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

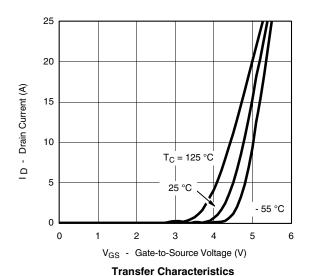


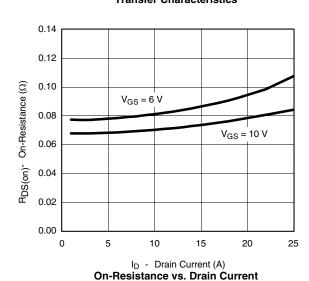
TYPICAL CHARACTERISTICS (25 °C unless noted)

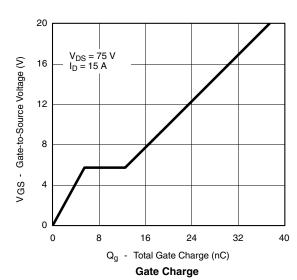




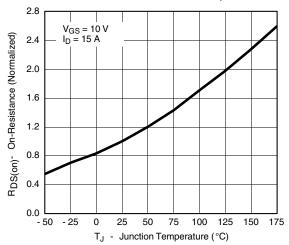








TYPICAL CHARACTERISTICS (25 °C unless noted)



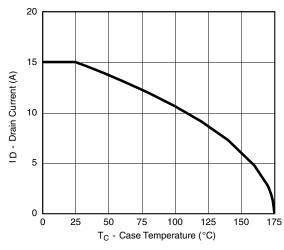
On-Resistance vs. Junction Temperature

Source Current (A) T_J = 150 °C 10 T_J = 25 °C တ 0 0.3 0.6 1.2 V_{SD} - Source-to-Drain Voltage (V)

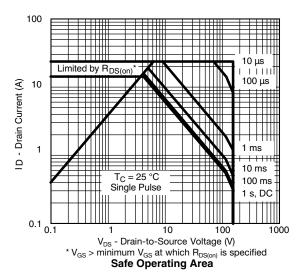
100

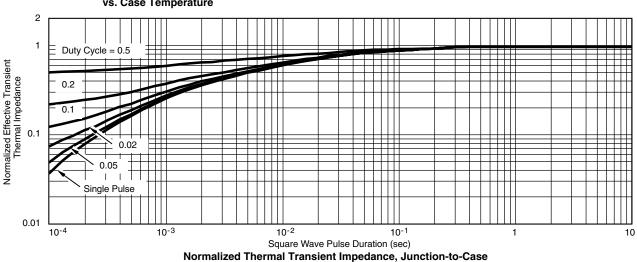
Source-Drain Diode Forward Voltage

THERMAL RATINGS



Maximum Avalanche Drain Current vs. Case Temperature



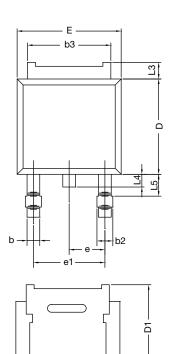


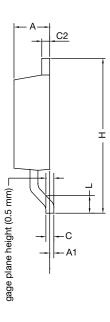
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon

Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71641.



TO-252AA Case Outline





	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC 0.090		BSC	
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16					

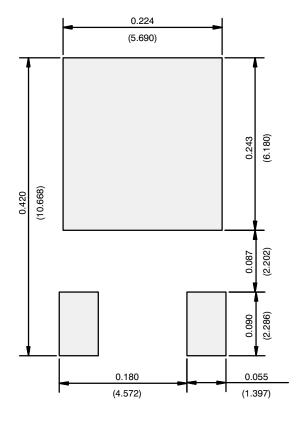
DWG: 5347 Notes

• Dimension L3 is for reference only.

Revision: 16-May-16 Document Number: 71197



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

APPLICATION NOTE



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